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## U.S. PATENT DOCUMENTS

| *Examiner Initial |    | Document Number | Date     | Name               | Class | Subclass | Filing Date If Appropriate |
|-------------------|----|-----------------|----------|--------------------|-------|----------|----------------------------|
| J.H.              | AA | 6,187,679       | 2/13/01  | Cabral, Jr. Et al. |       |          |                            |
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|                   | AJ |                 |          |                    |       |          |                            |

## FOREIGN PATENT DOCUMENTS

|  |    | Document Number | Date | Country | Class | Subclass | Translation |    |
|--|----|-----------------|------|---------|-------|----------|-------------|----|
|  |    |                 |      |         |       |          | Yes         | No |
|  | AK |                 |      |         |       |          |             |    |
|  | AL |                 |      |         |       |          |             |    |

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|      | AP |  |   |  |  |  |  |  |

EXAMINER

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